A. Dosil Suárez (On behalf of **the LHCb collaboration**)

2012 Nuclear Science Symposium, Medical Imaging Conference & Workshop on Room-Temperature Semiconductor X-Ray and Gamma-Ray Detectors 29th October - 3rd November, 2012 Anaheim, California



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The LHCb experiment

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Outline



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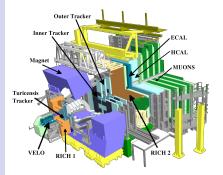
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The LHCb experiment



LHCb is a forward spectrometer designed to study flavor physics exploiting the enormous production cross sections of heavy hadrons at the LHC



- Excellent vertex, momentum and particle identification
- Design luminosity lower than the LHC can deliver.
 - → Built for $\mathcal{L} = 2 \times 10^{32} \text{cm}^{-2} \text{s}^{-1}$ at 25 ns spacing, with an average of μ =0.4 interactions per bunch crossing
 - \rightarrow Running at a $\mathcal{L} = 4 \times 10^{32} \text{ cm}^{-2} \text{s}^{-1}$ at 50 ns spacing with μ =1.4
 - $\rightarrow\,$ Has recorded 1.1 fb $^{-1}$ in 2011 and 1.63 fb $^{-1}$ so far in 2012
- Running at higher luminosity does not improve hadronic event yield due to trigger bottleneck

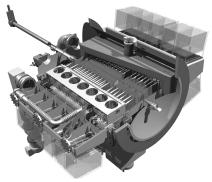
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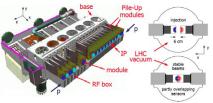
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The Vertex Locator (VELO)

- Silicon strip detector surrounding the interaction point
- 88 silicon n⁺-on-n sensors, 300 μ m thick, R- ϕ design
- · Located only 8 mm from the beams
- Enclosed into a separated vacuum box (RF Foil)
- · Halves are separated for beams injection
- 1 MHz trigger rate
- Bi-phase CO₂ cooling system







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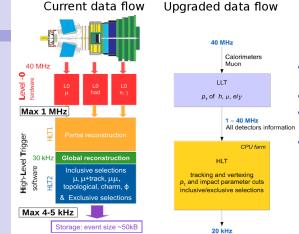
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LHCb upgrade

• Remove Hardware trigger. Use software-only trigger

- 1 to 40 MHz trigger rate
- Output rate from 5 to 20 kHz
- Increase luminosity to $\geq 2 \times 10^{33} \text{cm}^{-2} \text{s}^{-1}$

Apart from the increase in luminosity and trigger rate, we expect an increment of approx. a factor 10 and 20 in the muonic and hadronic channels yield respectively.

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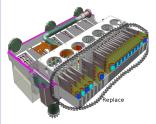
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VELO upgrade



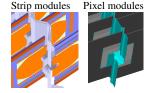
Requirements and challenges

- Data-driven readout at 40 MHz. >2 Tbit/s from whole VELO
- Radiation tolerance. Higly non-uniform radiation: $4.8 \times r^{-1.9}$ hits event⁻¹cm⁻²
- Keep/improve performance
- Increase granularity to allow operation at $\mathcal{L} \geq 2 \times 10^{33} \text{cm}^{-2} \text{s}^{-1}$



- Sensors, electronics, modules and RF foil need to be replaced.
- Vacuum tank, cooling plant and motion system will be re-used.

- Two options under investigation:
 - \rightarrow Pixel detector based on TimePix family of chips
 - $\rightarrow~$ Strip detector following similar philosophy to existing design





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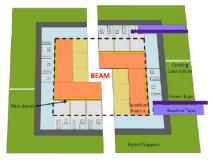
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Pixel option

- based on Velopix ASIC (successor of Timepix3) 55 μm x 55 μm pixel size, 256 x 256 matrix
 - → simultaneous measurement of time-over-threshold (ToT) and time-of-arrival (ToA)
 - \rightarrow peaking time < 25 ns, timewalk < 25 ns
 - \rightarrow hit rate up to 500 MHz. (Above 12 Gbit/s)
 - \rightarrow submission planned for early 2014
- L-shaped half modules with two blocks of 6 chips
- Closest pixel is at ≤7.5 mm from the beam center
- sensor R&D focussing on planar Si sensors
- alternative sensor technologies:
 - \rightarrow 3D sensors
 - → diamond sensors









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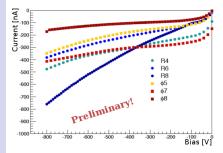
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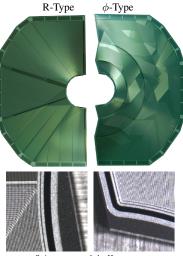
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Strip option

- conceptually similar to existing detector $(\mathbf{R}/\phi \text{ geometry})$
- increased number of strips, reduced pitch and strip length, lighter (200 μ m)
- improved routing line layout
- variable pitch designed for ≈ same occupancy per strip
- To be tested in coming test beams
- new strip chip being developed (synergy with other LHCb silicon detectors)
 - $\rightarrow\,$ on-chip common mode suppression, zero suppression, and clustering







Strip sensors made by Hamamatsu

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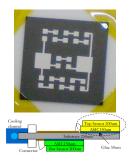
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Cooling



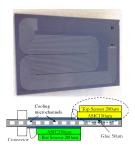
Metallised diamond substrate

- Thermally is highly conductive
- · Electrically is highly resistive
- Traces for chip IO deposited with thermally activated silver paste



Microchannel cooling option

- Build $\sim 200 \ \mu m \times 70 \ \mu m$ channels etched onto silicon
- The layout can be customized according to cooling needs
- Same coefficient of expansion than ASIC
- Several prototypes already produced and working in lab environment



Aim to re-use current CO2 cooling plant

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RF foil

The RF foil is a de facto beam pipe

Severe requirements:

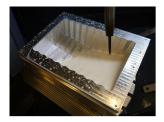
- Vacuum tight ($< 10^{-9}$ mbar l/s)
- Radiation hard
- Low mass but rigid to prevent deflection onto the sensors or pinhole leaks
- Good electrical conductivity to mirror beam currents and shield against RF noise pick-up in FE electronics
- Thermally stable and conductive (heat load from the beam)







Material and fabrication:



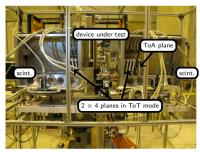
- Mill foil from solid Al alloy block
- By 5-axis milling head
- Achieve 200-350 μm thickness
- More flexibility to change shape than made by pressing method

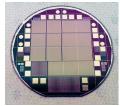
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Test beam TimePix telescope

- Constructed for LHCb upgrade
- Timepix assemblies (with 300 μm sensors) used as telescope planes (8 ToT + 1 ToA)
- device under test can be moved/rotated and cooled (portable CO₂ cooling plant)
- Resolution at the DUT plane $\leq 2\mu$ m (with 180 GeV/c π beam)
- Track time-stamping with
 - $\rightarrow~pprox$ 1 ns resolution
 - $ightarrow \, pprox$ 3-12 kHz track rate
- available to external users within the framework of AIDA WP 9.3



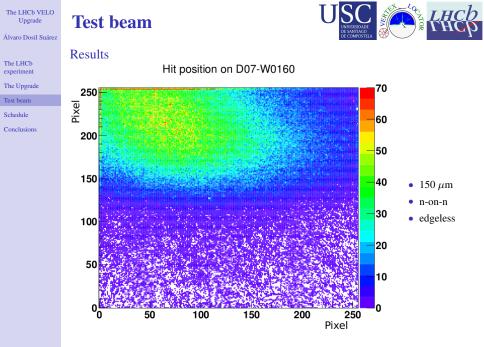




Sensor wafer with variable guard ring designs (Tiles 2-1 and 3-1. CNM)

Focus on

- sensor performance after irradiation (Medipix3 assemblies)
- evaluation of guard-ring designs, edge efficiencies
- prototype strip module



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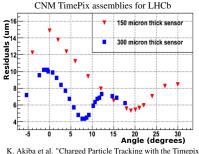
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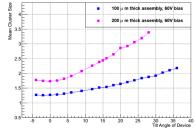




X. Akiba et al. "Charged Particle Tracking with the Timepix ASIC", Nucl. Instr. and Meth. A. NIMA53849, doi: 10.1016/j.nima.2011.09.021.



VTT edgeless Timepix assemblies for LHCb



Cluster width distribution for edgeless sensors

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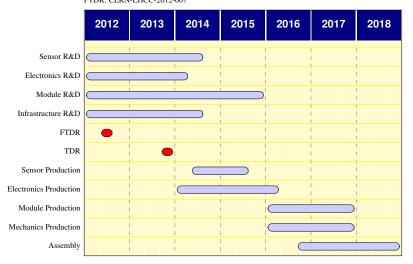
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LoI: CERN-LHCC-2011-001 FTDR: CERN-LHCC-2012-007



... to be installed in LHC Long Shutdown 2, in 2018-2019

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The requirements for the LHCb VELO upgrade are very demanding:

- Luminosity will be increased by a factor ≥ 10
- Trigger readout will be increased by a factor of 40
- Keep or improve the performance of the current VELO

R&D effort is underway:

- · For modules, pixel and strip detector options are being developed in parallel
- Cooling solutions like metallised diamond or microchannel also being investigated
- Material budget reduction in elements placed in the acceptance (modules, RF-Foil)
- Intense testbeam program to study: sensor technologies, radiation hardness, cooling schemes and readout electronics

Installation during long shutdown 2 in 2018

Have a magical day!





Work on going...